

Fig. 1

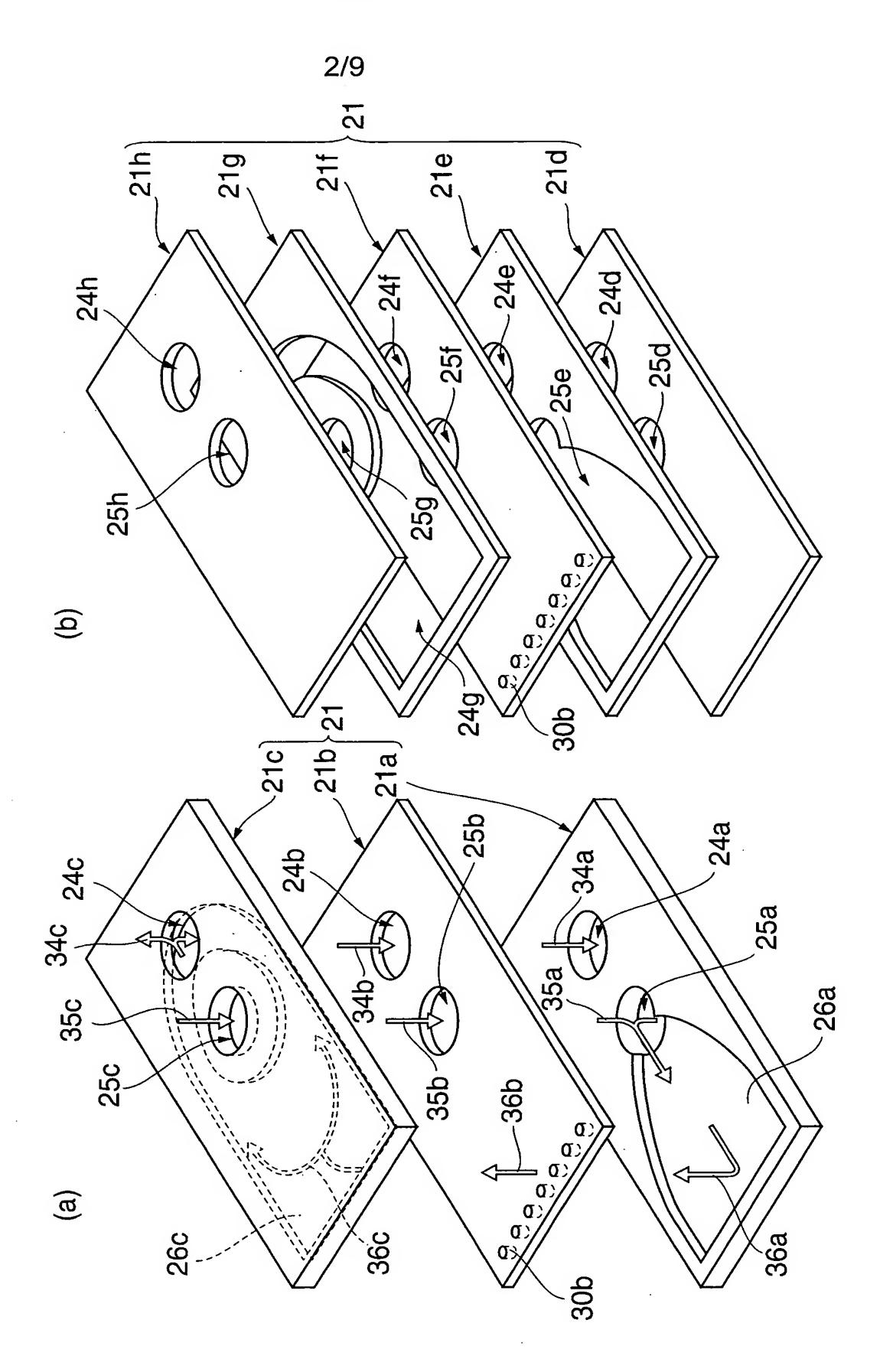
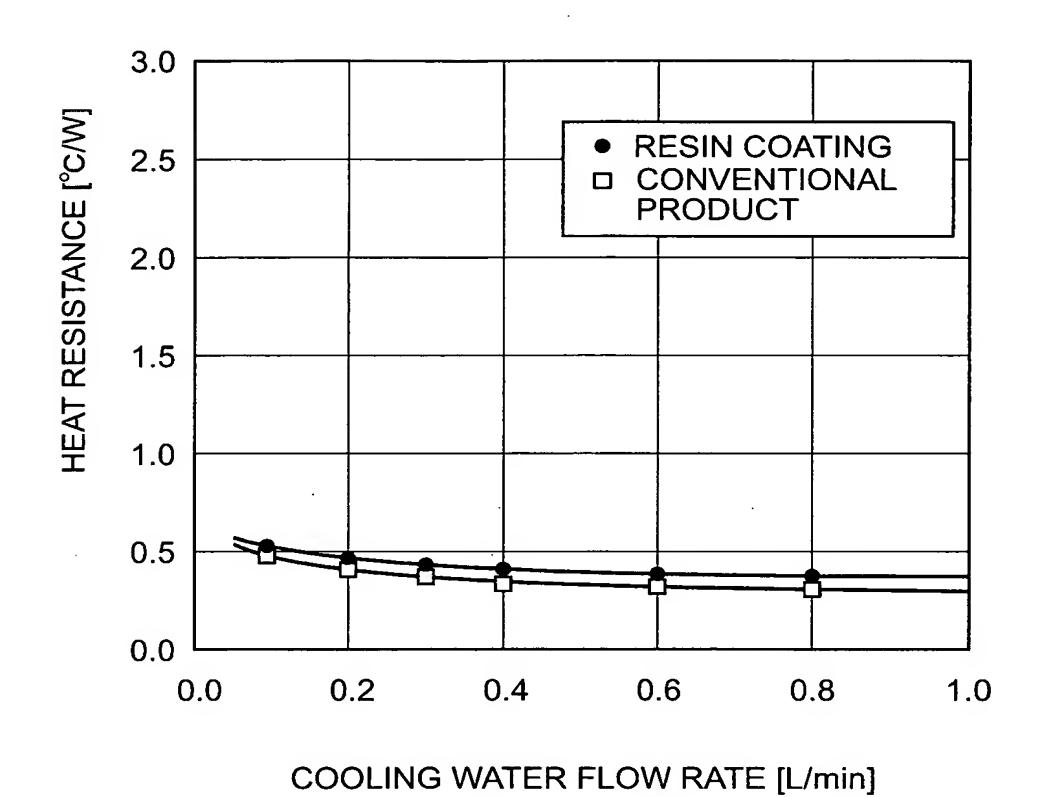


Fig. 7

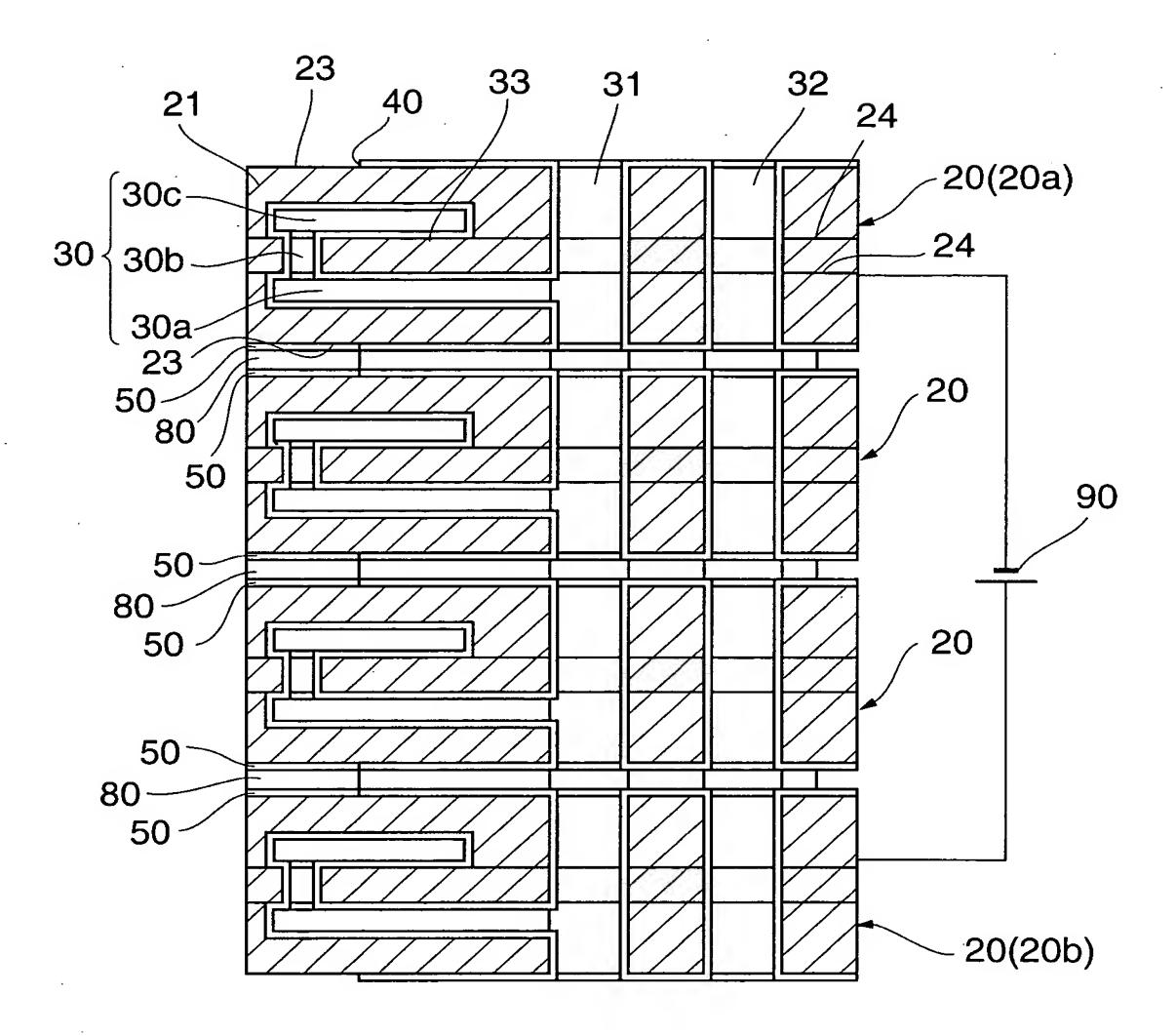
Fig.3



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LOWNESS OF COST		⊚(INEXPENSIVE)	O(RELATIVELY INEXPENSIVE)	△(RELATIVELY EXPENSIVE)	O(RELATIVELY INEXPENSIVE)	× (EXPENSIVE)	× (EXPENSIVE)	× (EXPENSIVE)	× (EXPENSIVE)	× (EXPENSIVE)
PERFORMANCE EVALUATION	THERMAL CHARACTERISTICS	V	4	۵	×	×	×		©	0
	ELECTRICAL INSULATING PROPERTY		0	0	0	©	0		0	0
	DENSENESS (NON-PRESENCE) OF PINHOLES	0	0	0	×	0	0		0	0
	WATER RESISTANCE	0	◁	◁	0	0	▽		I	l
	ADHESION	©	0	٥	×	0	0		l	l
	EASE OF FORMING	0	Δ	×	×	7	×	×	×	7
MATERIAL		EPOXY-BASED	ACRYLIC-BASED	SILICONE	URETHANE	POLYIMIDE	FLUORINE-BASED		DIAMOND	DLC (Diamond Like Carbon)
CLASSIFICATION		POLYMER						CERAMIC	OTHERS	

NOTE @.....EXCELLENT
O.....GOOD
A.....POOR
×....EXTREMELY
POOR

Fig.5



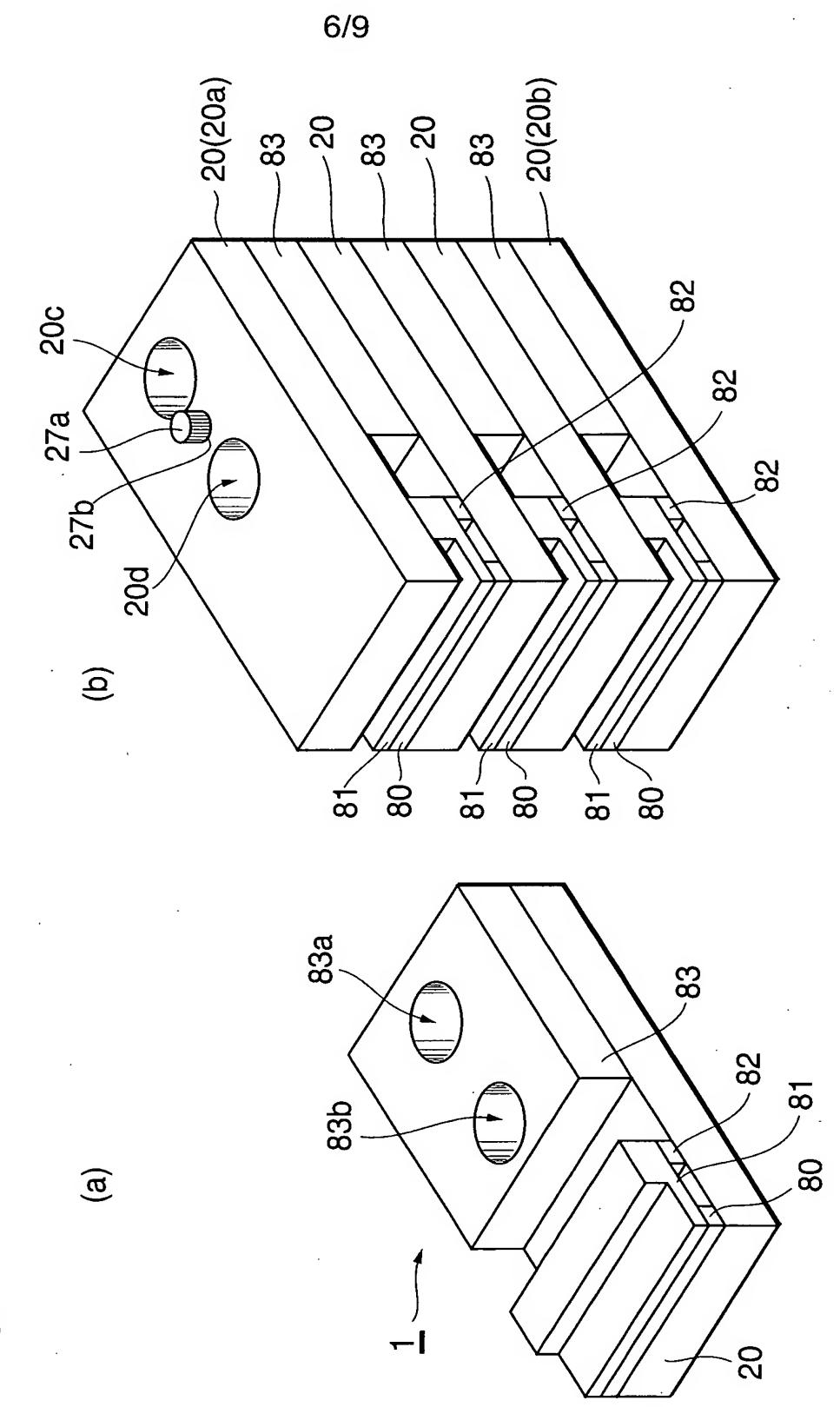
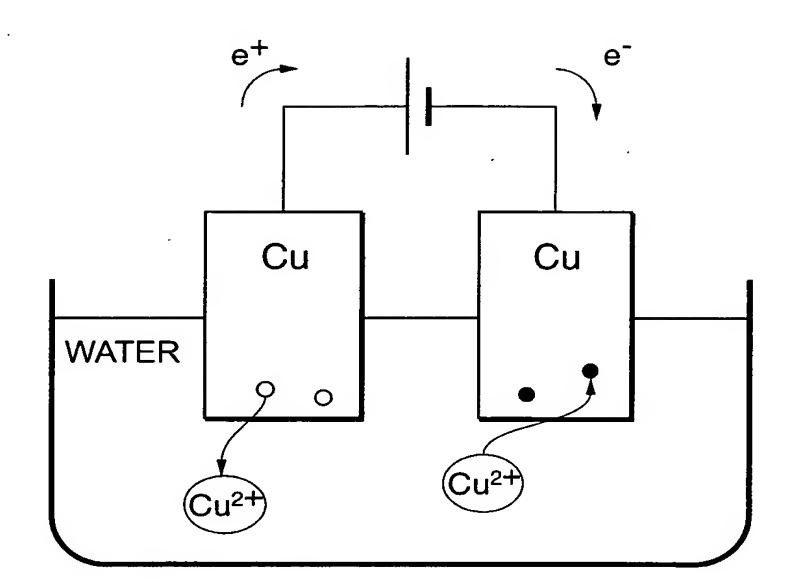


Fig.6

Fig.7



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Fig.8

